ZAMOKO70.

DECLARATION FOR PATENT APPLICATION		Doc	cket Number Optional)	
As a below named inventor, 1 hereby declare that: My residence, post office address and citizenship are as stated below next to				MR1035-1433
I believe I am the original, first and	ess and citizenship are a sole inventor (if only one nam	is stated below no se is listed below) or	ext to my name. · an original first ar	nd ioint inventor (if nlural name
are listed below) of the subject mat				
REFORMED WAFER BOAT				
, the specification of which is attac	hed hereto unless the foll	lowing box is che	cked:	
was filed on	as United	States Application	Number or PCT I	nternational Application
Number		mended on		(if applicable).
I hereby state that I have reviewed	and understand the contents	s of the above identi	fied specification, i	ncluding the claims, as
amended by any amendment refe I acknowledge the duty to disclose in	rred to above. Aformation which is material to	natontahility as defi	ned in 37 CER 81	56
I hereby daim foreign priority benefit	s under 35 U.S.C. § 119(a)-(d	 or § 365(b) of anv 	foreign application(s) for patent or inventor's
certificate, or § 365(a) of any PCT Into	emational application which de	signated at least one	country other than t	the United States, listed
below and have also identified below International application having a filir	v, by checking the box, any for	reign application for	patent or inventor's rituis daimed	certificate, or PCT
Prior Foreign Application(s)	ig date before it lat of the appli	Callott Off Which pho	nty is dail flou.	Priority Not Claimed
(,)				Š
(Number)	(Country)	(Day/Mor	th/Year Filed)	
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(Number)	(Country)		nth/Year Filed)	
I hereby daim the benefit under 35 t	U.S.C § 119(e) of any United	States provisional ap	pplication(s) listed b	pelow.
(Application Number)	(Filing	Date)		
(Application Number)	(i iiii i)	Date		
(Application Number)	(Filing	Date)		
I hereby daim the benefit under 35 t			8 365(c) of any P0	CT International application
designating the United States, listed by	pelowand insofar as the subje	ct matter of each of the	ne daims of this apr	olication is not disclosed
in the prior United States or PCT Interest	emational application in the m	anner provided by th	ne first naragraph o	f35USC 8112
In the prior Office States of PCT into	formation which is material to n	atina piovidadiby ii		which become a piloble
I acknowledge the duty to disclose int	omaton who is material to p		a data of this conti	willian becail le available
between the filing date of the prior ap	oplication and the national or F	PC i International filir	ng date of this appli	cauon.
(Application Number)	(Filing Da	ate)	(Status-patented	, pending, abandoned)
(4		-1->	(Otat tareta d	
(Application Number) I hereby appoint the following attorned	(Filing Da			, pending, <i>abandoned)</i>
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belief are believed to be true, and fi	irther that these statements w	ere made with the k	nowledge that willfu	ul false statements and the
like so made are punishable by fine or	imprisonment, or both, under S	ection 1001 of Title 18	3 of the United State	s Code and that such
willful false statements may jeopard		• •		
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_			Date3/	8/2004
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